

Final datasheet

EasyDUAL module with CoolSiC™ Trench MOSFET and PressFIT / NTC

Features

- · Electrical features
 - V_{DSS} = 1200 V
 - $I_{DN} = 150 \text{ A} / I_{DRM} = 300 \text{ A}$
 - Low switching losses
 - Low inductive design
 - High current density
 - Suitable Infineon gate drivers can be found under https://www.infineon.com/gdfinder
- Mechanical features
 - Rugged mounting due to integrated mounting clamps
 - PressFIT contact technology
 - Integrated NTC temperature sensor

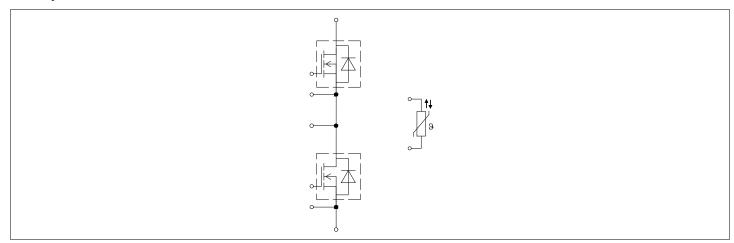
Potential applications

- UPS systems
- High-frequency switching application
- DC/DC converter
- Solar applications

Product validation

• Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description





EasyDUAL module

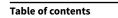




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EasyDUAL module

1 Package



1 Package

Table 1 Insulation coordination

| Parameter | Symbol | Note or test condition | Values | Unit |
|-------------------------------------|------------------------|---------------------------------------|--------------------------------|------|
| Isolation test voltage | V _{ISOL} | RMS, f = 50 Hz, t = 1 min | 3.0 | kV |
| Isolation test voltage NTC | V _{ISOL(NTC)} | RMS, f = 50 Hz, t = 1 min | 3.0 | kV |
| Internal isolation | | basic insulation (class 1, IEC 61140) | Al ₂ O ₃ | |
| Comparative tracking index | СТІ | | > 200 | |
| Relative thermal index (electrical) | RTI | housing | 140 | °C |

Table 2 Characteristic values

| Parameter | Symbol N | Note or test condition | Values | | | Unit |
|---|----------------------|------------------------------------|--------|------|------|------|
| | | | Min. | Тур. | Мах. | |
| Stray inductance module | L _{sCE} | | | 8 | | nH |
| Module lead resistance, terminals - chip | R _{CC'+EE'} | T _H = 25 °C, per switch | | 1.4 | | mΩ |
| Storage temperature | $T_{\rm stg}$ | | -40 | | 125 | °C |
| Mounting force per clamp | F | | 40 | | 80 | N |
| Weight | G | | | 39 | | g |

Note: The current under continuous operation is limited to 25 A rms per connector pin.

2 MOSFET

Table 3 Maximum rated values

| Parameter | Symbol | Note or test condition | | Values | Unit |
|---|------------------|--|-------------------------|--------|------|
| Drain-source voltage | $V_{\rm DSS}$ | | T _{vj} = 25 °C | 1200 | V |
| Implemented drain current | I _{DN} | | | 150 | А |
| Continuous DC drain current | I _{DDC} | $T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = 18 V | T _H = 65 °C | 145 | А |
| Repetitive peak drain current | / _{DRM} | verified by design, t _p limited by T _{vjmax} | | 300 | А |
| Gate-source voltage, max. transient voltage | V _{GS} | D < 0.01 | | -10/23 | V |
| Gate-source voltage, max. static voltage | V_{GS} | | | -7/20 | V |

EasyDUAL module

2 MOSFET



Table 4 Recommended values

| Parameter | Symbol | Note or test condition | Values | Unit |
|------------------------|----------------------|------------------------|--------|------|
| On-state gate voltage | V _{GS(on)} | | 1518 | V |
| Off-state gate voltage | V _{GS(off)} | | -50 | V |

Table 5 Characteristic values

| Parameter | Symbol | Note or test condition | | | Values | | Unit |
|--------------------------------|---------------------|---|---|------|--------|------|------|
| | | | | Min. | Тур. | Max. | |
| Drain-source on-resistance | R _{DS(on)} | I _D = 150 A | $V_{\rm GS} = 18 \text{V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$ | | 5.4 | 8 | mΩ |
| | | | $V_{\rm GS} = 18 \text{ V},$ $T_{\rm vj} = 125 ^{\circ}\text{C}$ | | 8.7 | | _ |
| | | | $V_{\rm GS} = 18 \text{ V},$ $T_{\rm vj} = 175 ^{\circ}\text{C}$ | | 11.6 | | |
| | | | $V_{\rm GS} = 15 \text{ V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$ | | 6.5 | | |
| Gate threshold voltage | V _{GS(th)} | $I_D = 60 \text{ mA}, V_{DS} = V_{GS}, T_{vj} = 1 \text{ms pulse at } V_{GS} = +20 \text{ V})$ | = 25 °C, (tested after | 3.45 | 4.3 | 5.15 | V |
| Total gate charge | Q_{G} | $V_{\rm DD}$ = 800 V, $V_{\rm GS}$ = -3/18 V, | T _{vj} = 25 °C | | 0.446 | | μC |
| Internal gate resistor | R _{Gint} | T _{vj} = 25 °C | | | 1.4 | | Ω |
| Input capacitance | C _{ISS} | $f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$ | T _{vj} = 25 °C | | 13.2 | | nF |
| Output capacitance | C _{OSS} | $f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$ | T _{vj} = 25 °C | | 0.63 | | nF |
| Reverse transfer capacitance | C _{rss} | $f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$ | T _{vj} = 25 °C | | 0.042 | | nF |
| C _{OSS} stored energy | E _{OSS} | $V_{\rm DS}$ = 800 V, $V_{\rm GS}$ = -3/18 V, | T _{vj} = 25 °C | | 258 | | μJ |
| Drain-source leakage current | I _{DSS} | $V_{\rm DS}$ = 1200 V, $V_{\rm GS}$ = -3 V | T _{vj} = 25 °C | | 0.09 | 530 | μA |
| Gate-source leakage current | I _{GSS} | $V_{\rm DS}$ = 0 V, $T_{\rm vj}$ = 25 °C | V _{GS} = 20 V | | | 400 | nA |
| Turn-on delay time | t _{d on} | $I_{\rm D} = 150 \text{A}, R_{\rm Gon} = 2.7 \Omega,$ | T _{vj} = 25 °C | | 31 | | ns |
| (inductive load) | | $V_{\rm DD} = 600 \text{ V}, V_{\rm GS} = -3/18 \text{ V},$ $t_{\rm dead} = 1000 \text{ ns}, 0.1 \text{ V}_{\rm GS}$ | T _{vj} = 125 °C | | 31 | | 1 |
| | | to 0.1 I _D | T _{vj} = 175 °C | | 32 | | |
| Rise time (inductive load) | t _r | $I_{\rm D} = 150 \text{A}, R_{\rm Gon} = 2.7 \Omega,$ | T _{vj} = 25 °C | | 13 | | ns |
| | | $V_{\rm DD}$ = 600 V, $V_{\rm GS}$ = -3/18 V, | T _{vj} = 125 °C | | 13 | | |
| | | t_{dead} = 1000 ns, 0.1 I _D to 0.9 I _D | T _{vj} = 175 °C | | 14 | | |

(table continues...)

EasyDUAL module

2 MOSFET



Table 5 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | | | Values | | Unit |
|--|--------------------|--|---|------|--------|------|------|
| | | | | Min. | Тур. | Max. | |
| Turn-off delay time | t _{d off} | $I_{\rm D} = 150 \text{A}, R_{\rm Goff} = 0.51 \Omega,$ | T _{vj} = 25 °C | | 35 | | ns |
| (inductive load) | | $V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V},$ 0.9 V_{GS} to 0.9 I_{D} | T _{vj} = 125 °C | | 38 | | |
| | | 0.5 VGS to 0.5 10 | T _{vj} = 175 °C | | 41 | | |
| Fall time (inductive load) | t _f | $I_{\rm D} = 150 \text{ A}, R_{\rm Goff} = 0.51 \Omega,$ | T _{vj} = 25 °C | | 11 | | ns |
| | | $V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V},$ 0.9 I _D to 0.1 I _D | T _{vj} = 125 °C | | 12 | | |
| | | 0.5 10 to 0.1 10 | T _{vj} = 175 °C | | 16 | | |
| Turn-on energy loss per | E _{on} | $I_{\rm D}$ = 150 A, $V_{\rm DD}$ = 600 V, | T _{vj} = 25 °C | | 2.12 | | mJ |
| pulse | | $L_{\sigma} = 8 \text{ nH}, V_{GS} = -3/18 \text{ V},$ $R_{Gon} = 2.7 \Omega, \text{ di/dt} =$ | T _{vj} = 125 °C | | 2.35 | | |
| | | 13.5 kA/ μ s (T_{vj} = 175 °C), t_{dead} = 1000 ns | T _{vj} = 175 °C | | 2.67 | | |
| Turn-on energy loss per | E _{on,o} | $I_{\rm D}$ = 150 A, $V_{\rm DD}$ = 600 V, | T _{vj} = 25 °C | | 1.28 | | mJ |
| pulse, optimized | | $L_{\sigma} = 8 \text{ nH}, V_{\text{GS}} = -3/18 \text{ V},$ $R_{\text{Gon,o}} = 1.5 \Omega, \text{ di/dt} =$ $18.1 \text{ kA/}\mu\text{s} (T_{\text{vj}} = 175 ^{\circ}\text{C}),$ $t_{\text{dead}} = 100 \text{ ns}$ | T _{vj} = 125 °C | | 1.3 | | |
| | | | T _{vj} = 175 °C | | 1.35 | | |
| Turn-off energy loss per | E _{off} | $I_{\rm D}$ = 150 A, $V_{\rm DD}$ = 600 V, | T _{vj} = 25 °C | | 0.41 | | mJ |
| pulse | | $L_{\sigma} = 8 \text{ nH}, V_{GS} = -3/18 \text{ V},$ $R_{Goff} = 0.51 \Omega, \text{ dv/dt} =$ | T _{vj} = 125 °C | | 0.434 | | |
| | | $42.5 \text{ kV/}\mu\text{s} (T_{\text{vj}} = 175 ^{\circ}\text{C})$ | T _{vj} = 175 °C | | 0.445 | | |
| SC data | I _{SC} | $V_{GS} = -5/15 \text{ V}, V_{DD} = 800 \text{ V},$ $V_{DSmax} = V_{DSS} - L_{sDS} * \text{di/dt},$ | $t_{\rm P}$ = 2 µs, $T_{\rm vj}$ = 25 °C | | 1260 | | А |
| | | $t_{\rm P}$ = 2 µs, $T_{\rm vj}$ = 150 °C | | 1230 | | | |
| Thermal resistance, junction to heat sink | R _{thJH} | per MOSFET, $\lambda_{\text{grease}} = 1 \text{ W}$ | /(m·K) | | 0.346 | | K/W |
| Temperature under switching conditions | T _{vj op} | | | -40 | | 175 | °C |

Note:

The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

Tvj,op > 150°C is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.

EasyDUAL module

3 Body diode (MOSFET)



3 Body diode (MOSFET)

Table 6 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|-----------------------|-----------------|--|------------------------|------|---|
| DC body diode forward | I _{SD} | $T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = -3 V | T _H = 65 °C | 75 | Α |
| current | | | | | |

Table 7 Characteristic values

| Parameter | Symbol | Note or test condition | | | Values | | Unit |
|------------------------------------|--------------------|---|--------------------------|------|--------|------|------|
| | | | | Min. | Тур. | Max. | |
| Forward voltage | V _{SD} | $I_{SD} = 150 \text{ A}, V_{GS} = -3 \text{ V}$ | T _{vj} = 25 °C | | 4.2 | 5.35 | V |
| | | | T _{vj} = 125 °C | | 3.9 | | |
| | | | T _{vj} = 175 °C | | 3.8 | | |
| Peak reverse recovery I_{rrm} | I _{rrm} | $I_{SD} = 150 \text{ A, di}_{s}/\text{dt} =$ | T _{vj} = 25 °C | | 106 | | А |
| current | | 13.5 kA/ μ s, V_{DD} = 600 V, V_{GS} = -3 V, t_{dead} = 1000 ns | T _{vj} = 125 °C | | 155 | | |
| | | VGS5 V, t _{dead} - 1000 HS | T _{vj} = 175 °C | | 175 | | |
| Recovered charge | Q _{rr} | I_{SD} = 150 A, di _s /dt = 13.5 kA/µs, V_{DD} = 600 V, V_{GS} = -3 V, t_{dead} = 1000 ns | T _{vj} = 25 °C | | 1.36 | | μC |
| | | | T _{vj} = 125 °C | | 2.47 | | |
| | | | T _{vj} = 175 °C | | 3.2 | | |
| Reverse recovery energy | E _{rec} | $I_{SD} = 150 \text{ A, di}_{s}/\text{dt} =$ | T _{vj} = 25 °C | | 0.521 | | mJ |
| | | 13.5 kA/ μ s (T_{vj} = 175 °C), V_{DD} = 600 V, V_{GS} = -3 V, | T _{vj} = 125 °C | | 0.863 | | |
| | | $t_{\text{dead}} = 1000 \text{ ns}$ | T _{vj} = 175 °C | | 1.16 | | |
| Reverse recovery energy, optimized | E _{rec,o} | $I_{SD} = 150 \text{ A, di}_{s}/\text{dt} =$ | T _{vj} = 25 °C | | 0.764 | | mJ |
| | | 18.1 kA/ μ s ($T_{vj} = 175$ °C), | T _{vj} = 125 °C | | 0.816 | | 1 |
| | | $V_{\rm DD}$ = 600 V, $V_{\rm GS}$ = -3 V, $t_{\rm dead}$ = 100 ns | T _{vj} = 175 °C | | 0.963 | | |

4 NTC-Thermistor

Table 8 Characteristic values

| Parameter | Symbol Note or test condition | | Unit | | | |
|-------------------------------|-------------------------------|--|------|------|------|----|
| | | | Min. | Тур. | Мах. | |
| Rated resistance | R ₂₅ | T _{NTC} = 25 °C | | 5 | | kΩ |
| Deviation of R ₁₀₀ | ∆R/R | $T_{\rm NTC} = 100 {}^{\circ}{\rm C}$, $R_{100} = 493 \Omega$ | -5 | | 5 | % |
| Power dissipation | P ₂₅ | T _{NTC} = 25 °C | | | 20 | mW |
| B-value | B _{25/50} | $R_2 = R_{25} \exp[B_{25/50}(1/T_2-1/(298,15 \text{ K}))]$ | | 3375 | | K |
| B-value | B _{25/80} | $R_2 = R_{25} \exp[B_{25/80}(1/T_2-1/(298,15 \text{ K}))]$ | | 3411 | | K |
| B-value | B _{25/100} | $R_2 = R_{25} \exp[B_{25/100}(1/T_2-1/(298,15 \text{ K}))]$ | | 3433 | | K |

Note: For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4.

EasyDUAL module

5 Characteristics diagrams

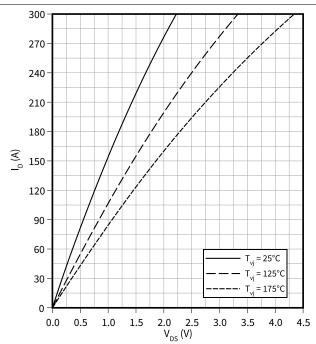


5 Characteristics diagrams

Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

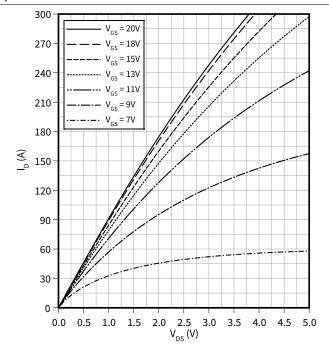
 $V_{GS} = 15 V$



Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

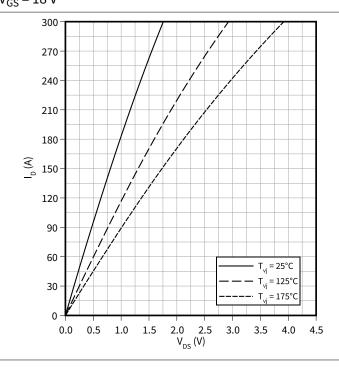
 $T_{vj} = 175$ °C



Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

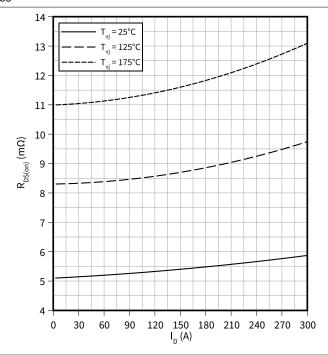
V_{GS} = 18 V



Drain source on-resistance (typical), MOSFET

 $R_{DS(on)} = f(I_D)$

 $V_{GS} = 18 V$



EasyDUAL module

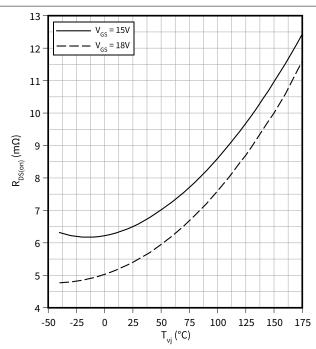




Drain source on-resistance (typical), MOSFET

$$R_{DS(on)} = f(T_{vj})$$

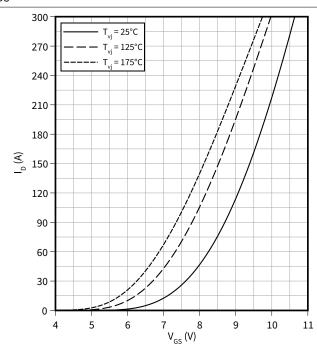
 $I_D = 150 A$



Transfer characteristic (typical), MOSFET

$$I_D = f(V_{GS})$$

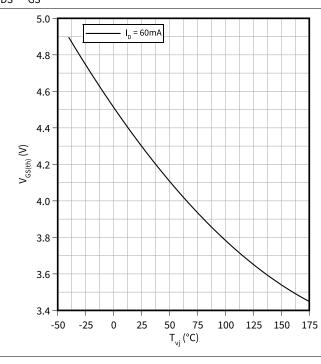
 $V_{DS} = 20 V$



Gate-source threshold voltage (typical), MOSFET

$$V_{GS(th)} = f(T_{vj})$$

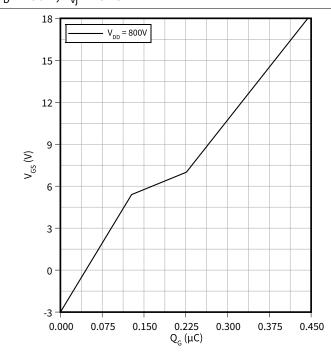
 $V_{DS} = V_{GS}$



Gate charge characteristic (typical), MOSFET

$$V_{GS} = f(Q_G)$$

$$I_D = 150 A$$
, $T_{vi} = 25 °C$



EasyDUAL module

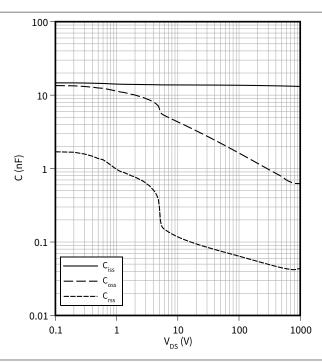
5 Characteristics diagrams



Capacity characteristic (typical), MOSFET

 $C = f(V_{DS})$

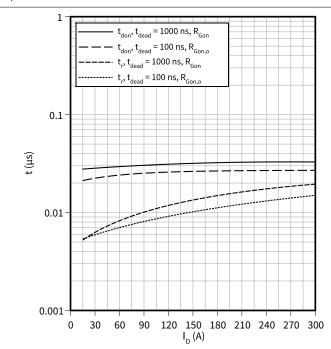
f = 100 kHz, $T_{vj} = 25 \,^{\circ}\text{C}$, $V_{GS} = 0 \,^{\circ}\text{V}$



Switching times (typical), MOSFET

 $t = f(I_D)$

 V_{DD} = 600 V, R_{Gon} = 2.7 $\Omega,\,R_{Gon,o}$ = 1.5 $\Omega,\,T_{vj}$ = 175 °C, V_{GS} = -3/18 V



Switching times (typical), MOSFET

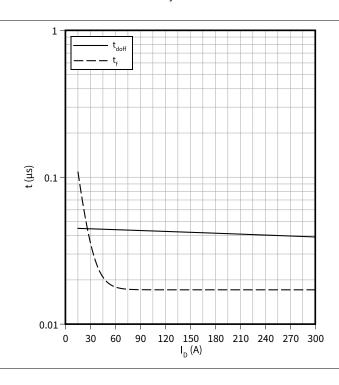
 $t = f(I_D)$

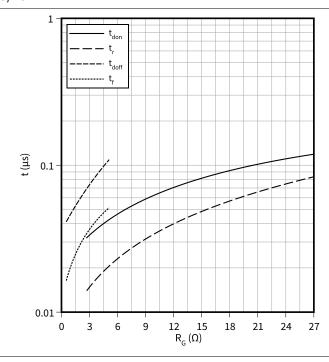
 R_{Goff} = 0.51 Ω , V_{DD} = 600 V, T_{vj} = 175 °C, V_{GS} = -3/18 V

Switching times (typical), MOSFET

 $t = f(R_G)$

 V_{DD} = 600 V, t_{dead} = 1000 ns, I_D = 150 A, T_{vj} = 175 °C, V_{GS} = -3/18 V





EasyDUAL module

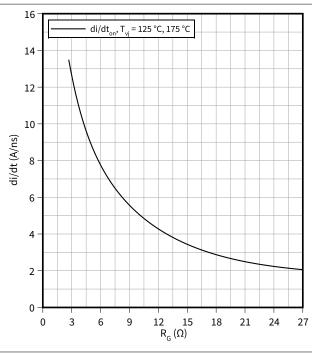
5 Characteristics diagrams



Current slope (typical), MOSFET

 $di/dt = f(R_G)$

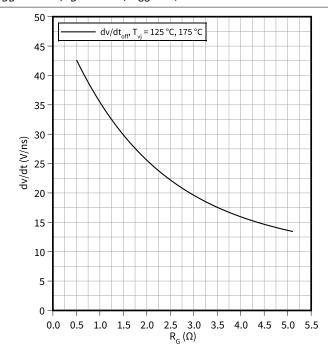
 V_{DD} = 600 V, t_{dead} = 1000 ns, I_{D} = 150 A, V_{GS} = -3/18 V



Voltage slope (typical), MOSFET

 $dv/dt = f(R_G)$

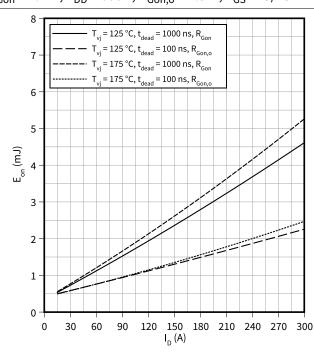
 $V_{DD} = 600 \text{ V}, I_D = 150 \text{ A}, V_{GS} = -3/18 \text{ V}$



Switching losses (typical), MOSFET

 $E_{on} = f(I_D)$

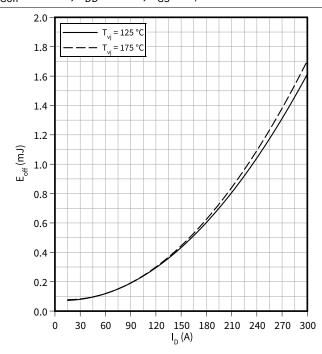
 R_{Gon} = 2.7 Ω , V_{DD} = 600 V, $R_{Gon,o}$ = 1.5 Ω , V_{GS} = -3/18 V



Switching losses (typical), MOSFET

 $E_{off} = f(I_D)$

 $R_{Goff} = 0.51 \Omega$, $V_{DD} = 600 V$, $V_{GS} = -3/18 V$



EasyDUAL module

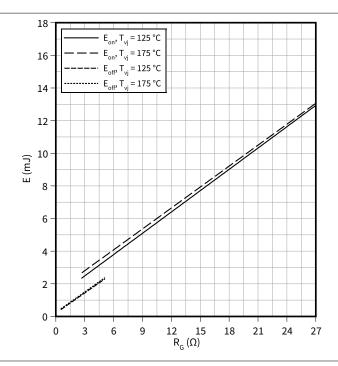
5 Characteristics diagrams



Switching losses (typical), MOSFET

 $E = f(R_G)$

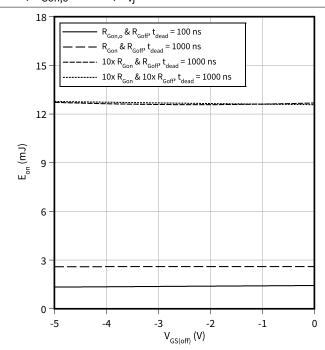
 V_{DD} = 600 V, t_{dead} = 1000 ns, I_{D} = 150 A, V_{GS} = -3/18 V



Switching losses (typical), MOSFET

 $E_{on} = f(V_{GS(off)})$

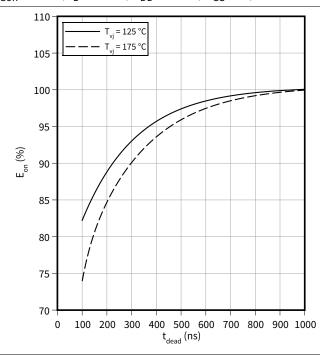
 R_{Goff} = 0.51 Ω , V_{DD} = 600 V, R_{Gon} = 2.7 Ω , $V_{GS(on)}$ = 18 V, I_{D} = 150 A, $R_{Gon,o}$ = 1.5 Ω , T_{vj} = 175 °C



Switching losses (typical), MOSFET

 $E_{on} = f(t_{dead})$

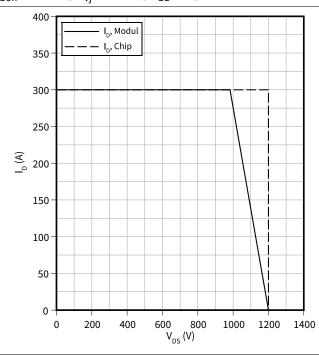
 $R_{Gon} = 2.7 \Omega$, $I_D = 150 A$, $V_{DD} = 600 V$, $V_{GS} = -3/18 V$



Reverse bias safe operating area (RBSOA), MOSFET

 $I_D = f(V_{DS})$

 $R_{Goff} = 0.51 \Omega$, $T_{vj} = 175 \, ^{\circ}C$, $V_{GS} = -3/18 \, V$



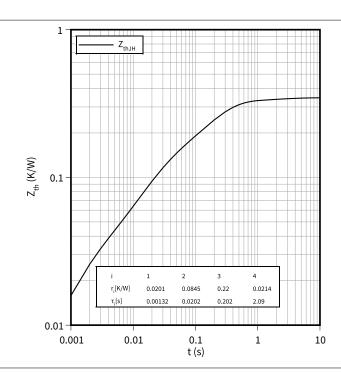
EasyDUAL module

5 Characteristics diagrams



Transient thermal impedance, MOSFET

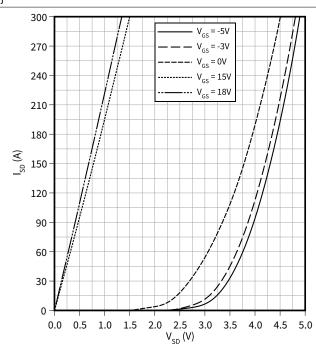
$$Z_{th} = f(t)$$



Forward characteristic body diode (typical), MOSFET

$$I_{SD} = f(V_{SD})$$

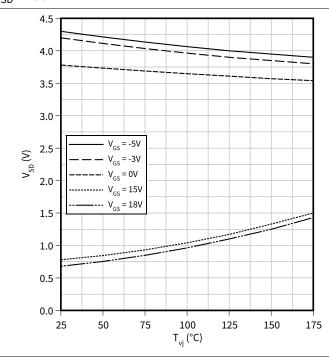
$$T_{vj} = 25 \, ^{\circ}C$$



Forward voltage of body diode (typical), MOSFET

$$V_{SD} = f(T_{vj})$$

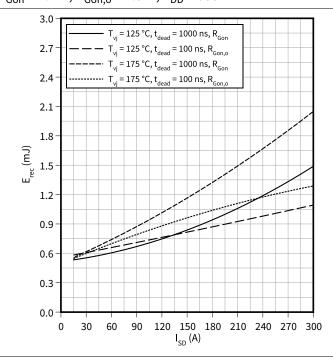
$$I_{SD} = 150 A$$



Switching losses body diode (typical), MOSFET

$$E_{rec} = f(I_{SD})$$

$$R_{Gon}$$
 = 2.7 Ω , $R_{Gon,o}$ = 1.5 Ω , V_{DD} = 600 V



EasyDUAL module

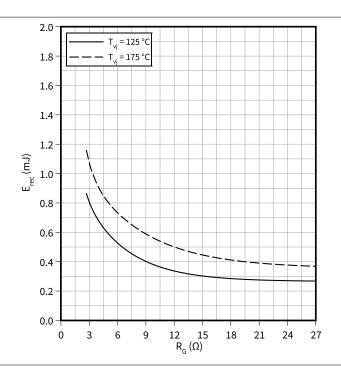
5 Characteristics diagrams



Switching losses body diode (typical), MOSFET

 $E_{rec} = f(R_G)$

 t_{dead} = 1000 ns, I_{SD} = 150 A, V_{DD} = 600 V

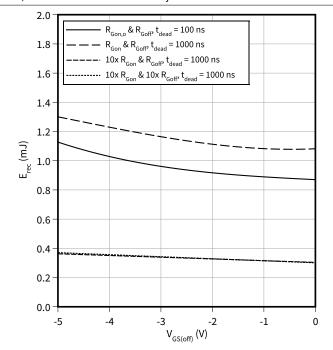


Switching losses body diode (typical), MOSFET

 $E_{rec} = f(V_{GS(off)})$

 $R_{Goff} = 0.51 \Omega$, $R_{Gon} = 2.7 \Omega$, $V_{GS(on)} = 18 V$, $I_{SD} = 150 A$,

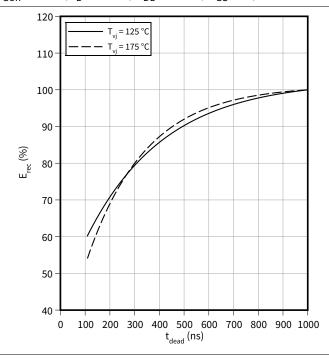
 $R_{Gon,o} = 1.5 \Omega, V_{DD} = 600 V, T_{vj} = 175 ^{\circ}C$



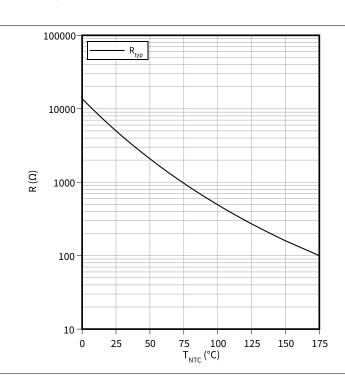
Switching losses body diode (typical), MOSFET

 $E_{rec} = f(t_{dead})$

 $R_{Gon} = 2.7 \Omega$, $I_D = 150 A$, $V_{DD} = 600 V$, $V_{GS} = -3/18 V$



Temperature characteristic (typical), NTC-Thermistor $R = f(T_{NTC})$



EasyDUAL module 6 Circuit diagram



Circuit diagram 6

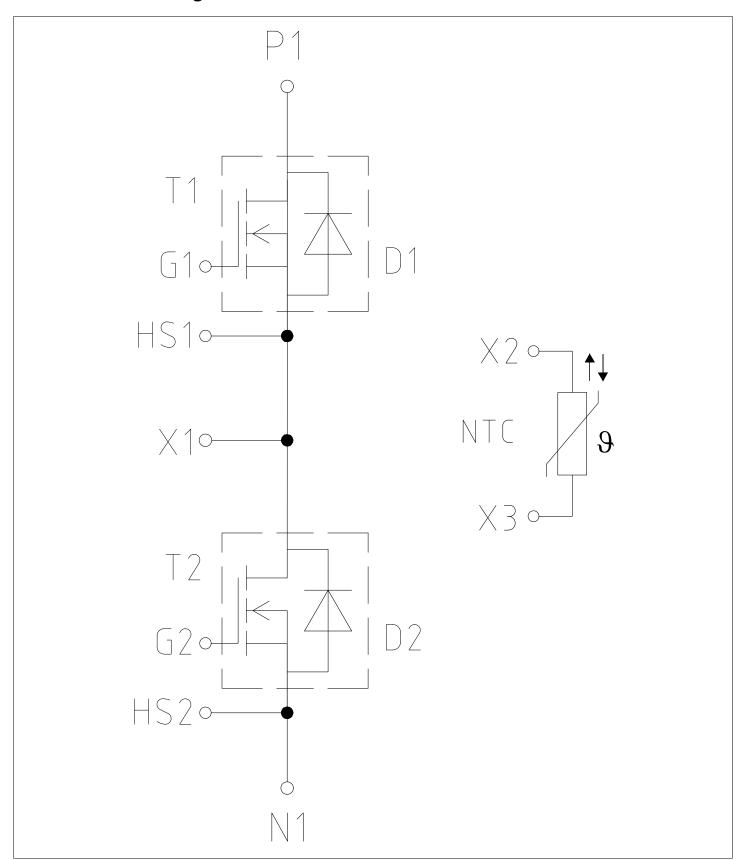


Figure 1

7 Package outlines



7 Package outlines

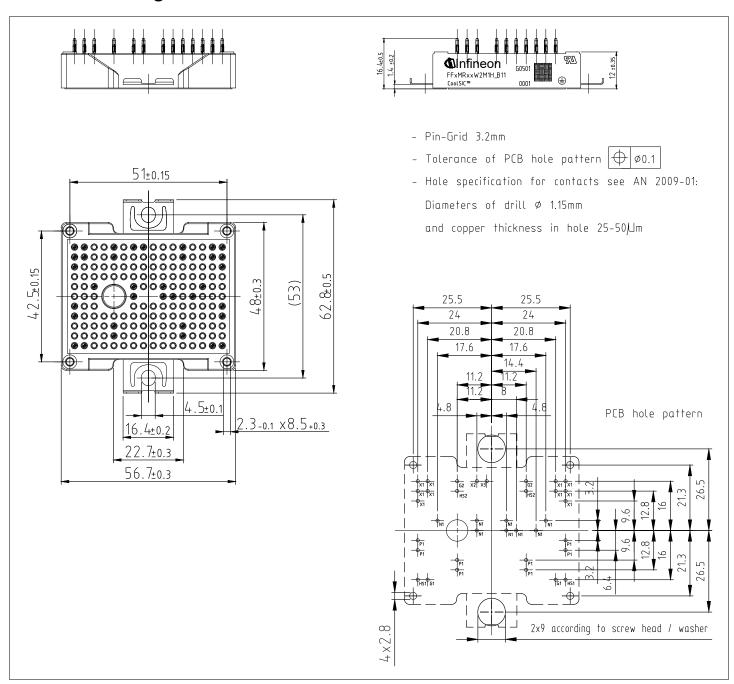


Figure 2

EasyDUAL module

8 Module label code



8 Module label code

| Code format | Data Matrix | | Barcode C | Code128 |
|--------------|---|--|-----------|--|
| Encoding | ASCII text | | Code Set | Ą |
| Symbol size | 16x16 | | 23 digits | |
| Standard | IEC24720 and IEC16022 | | IEC8859-1 | |
| Code content | Content Digit Module serial number 1 - 5 Module material number 6 - 11 Production order number 12 - 19 Date code (production year) 20 - 21 Date code (production week) 22 - 23 | | | Example 71549 142846 55054991 15 30 |
| Example | 71549142846550549911530 | | | 6550549911530 |

Figure 3

EasyDUAL module

Revision history



Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10 | 2022-11-07 | Initial version |
| 0.20 | 2023-05-12 | Preliminary datasheet |
| 1.00 | 2025-02-28 | Final datasheet |
| 1.10 | 2025-03-14 | Final datasheet |

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